ECST1V0805

SMT current sense transformer



Product features

- EE5.0 SMT package (8.38 mm x 8.0 mm x 5.5 mm)
- · Very low DC resistance
- Wide selection of turns ratios
- Sensed current primary rated for 10 A
- Frequency range: 50 kHz to 1 MHz
- Moisture sensitivity level (MSL): 1

Applications

- Switching power supplies
- · Feedback control
- · Overload sensing
- Load drop/shut down detection

Environmental compliance and general specifications

- Operating temperature range: -40 °C to +125 °C (ambient plus self-temperature rise)
- Solder reflow temperature: J-STD-020 (latest revision) compliant









Product specifications

Part number³	Turns ratio sec:pri	Secondary inductance (µH) @ 100 kHz 0.1 V minimum	DCR sec (Ω) maximum	DCR pri (mΩ) reference	Hi-pot pri to sec @ 2 mA 3 seconds 50 Hz	Sensed current¹ (A) maximum
ECST1V0805-1020-R	20:1	80	0.4	0.7	500 Vac	10
ECST1V0805-1030-R	30:1	180	0.87	0.7	500 Vac	10
ECST1V0805-1040-R	40:1	320	1.14	0.7	500 Vac	10
ECST1V0805-1050-R	50:1	500	1.85	0.7	500 Vac	10
ECST1V0805-1060-R	60:1	730	2.3	0.7	500 Vac	10
ECST1V0805-1070-R	70:1	980	4.75	0.7	500 Vac	10
ECST1V0805-1100-R	100:1	2000	5.5	0.7	500 Vac	10
ECST1V0805-1125-R	125:1	3000	11.5	0.7	500 Vac	10

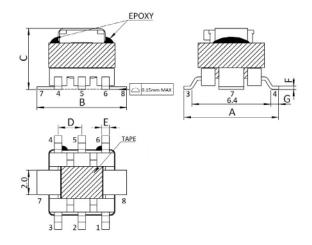
- 1. Primary current of 10 A causes less than 40°C temperature rise @ +25°C ambient. Higher current causes a greater temperature rise
- Electrical specifications at +25 °C
 Part Number Definition: ECST1V0805-1xxx-R

ECST1V0805 = Product code and size

1xxx= Turns ratio sec:pri; 1=pri, xxx=sec; 1020= 20:1

-R suffix = RoHS compliant

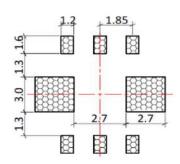
Mechanical parameters, schematic, pad layout (mm)



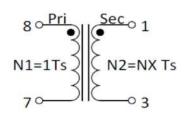
Dimension	Value
A	8.38 maximum
В	8.00 maximum
С	5.50 maximum
D	1.85 ±0.3
E	0.6
F	0.25 ref
G	0.7 ±0.2

Part marking: White dot, Pin 1 indicator All soldering surfaces to be coplanar within 0.15 millimeters Tolerances are ±0.1 millimeters unless stated otherwise Traces or vias underneath the inductor is not recommended

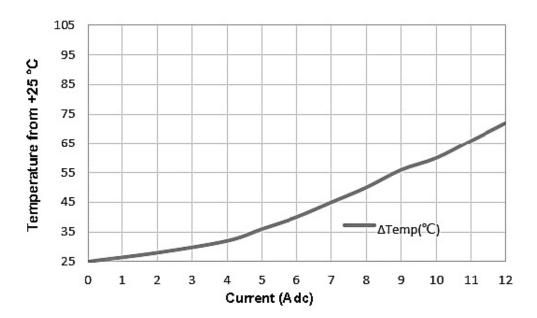
Recommended PCB Layout



Schematic



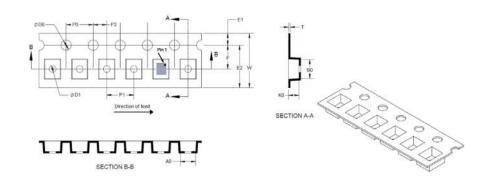
Temp rise vs current



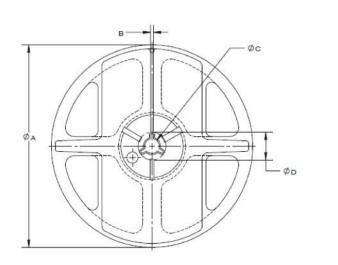
Packaging information (mm)

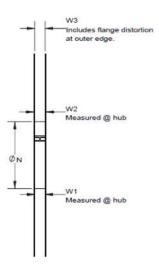
Supplied in tape and reel packaging, 13" diameter reel (EIA-481 compliant) 1000 parts per reel

Drawing is representative and not to scale.



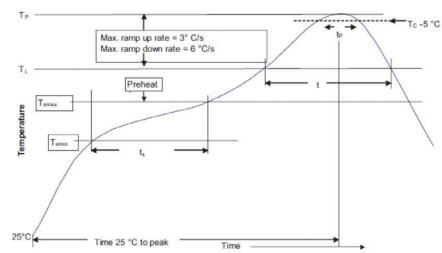
Dimension	Value
W	16 ±0.3
P1	12.0 ±0.1
E1	1.75 ±0.1
F	7.50 ±0.05
P2	2.0 ±0.05
D0	1.5 +0.1/-0
D1	1.5 +0.1/-0
B0	8.45 ±0.1
A0	7.7 ±0.2
KO	5.50 ±0.1
P0 4.0 ±0.1	
T	0.40 ±0.05





Dimension	Value	
A	330 ±3.0	
N	100 ±1.0	
С	13+0.5/-0.2	
W1	16.4+2.0/-0.0	

Solder reflow profile



T_C -5 °C Table 1 - Standard SnPb solder (T_C)

Package Thickness	Volume mm3 <350	Volume mm3 ≥350	
<2.5 mm)	235 °C	220 °C	
≥2.5 mm	220 °C	220 °C	

Table 2 - Lead (Pb) free solder (T_C)

Package thickness	Volume mm³ <350	Volume mm³ 350 - 2000	Volume mm³ >2000
<1.6 mm	260 °C	260 °C	260 °C
1.6 – 2.5 mm	260 °C	250 °C	245 °C
>2.5 mm	250 °C	245 °C	245 °C

Reference J-STD-020

ile feature	Standard SnPb solder	Lead (Pb) free solder	
eat and soak • Temperature min. (T _{smin})	100 °C	150 °C	
• Temperature max. (T _{smax})	150 °C	200 °C	
• Time (T _{smin} to T _{smax}) (t _s)	60-120 seconds	60-120 seconds	
up rate T _L to T _p	3 °C/ second max.	3 °C/ second max.	
dous temperature (T_L) (t_L) maintained above T_L	183 °C 60-150 seconds	217 °C 60-150 seconds	
package body temperature (Tp)*	Table 1	Table 2	
(t _p)* within 5 °C of the specified classification temperature (T _C)	20 seconds*	30 seconds*	
r-down rate (T _p to T _L)	6 °C/ second max.	6 °C/ second max.	
25 °C to peak temperature	6 minutes max.	8 minutes max.	
$(t_p)^*$ within 5 °C of the specified classification temperature (T_c) -down rate $(T_p$ to $T_L)$	20 seconds* 6 °C/ second max.	30 seconds* 6 °C/ second max.	

 $^{^{\}star}$ Tolerance for peak profile temperature (Tp) is defined as a supplier minimum and a user maximum.

Manual solder

30 W soldering iron. \pm 350 °C \pm 10 °C, 3 seconds maximum. Do not touch product with iron. Generally manual, hand soldering is not recommended.

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